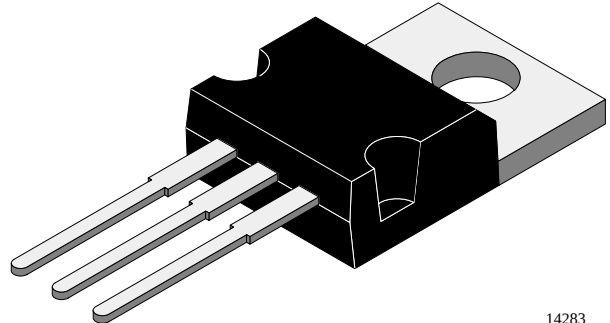


Silicon NPN High Voltage Switching Transistor

Features

- Monolithic integrated C-E-free-wheel diode
- HIGH SPEED technology
- Planar passivation
- Very short switching times
- Very low switching losses
- Very low dynamic saturation
- Very low operating temperature
- High reverse voltage



14283

Applications

Electronic lamp ballast circuits
Switch-mode power supplies

Absolute Maximum Ratings

$T_{case} = 25^{\circ}C$, unless otherwise specified

Parameter	Test Conditions	Type	Symbol	Value	Unit
Collector-emitter voltage		TE13004D	V_{CEO}	300	V
		TE13005D	V_{CEO}	400	V
		TE13004D	V_{CES}	600	V
		TE13005D	V_{CES}	700	V
Emitter-base voltage			V_{EBO}	9	V
Collector current			I_C	6	A
Collector peak current			I_{CM}	8	A
Base current			I_B	2	A
Base peak current			I_{BM}	4	A
Total power dissipation	$T_{case} \leq 25^{\circ}C$		P_{tot}	57	W
Junction temperature			T_j	150	$^{\circ}C$
Storage temperature range			T_{stg}	-65 to +150	$^{\circ}C$

Maximum Thermal Resistance

$T_{case} = 25^{\circ}C$, unless otherwise specified

Parameter	Test Conditions	Symbol	Value	Unit
Junction case		R_{thJC}	2.2	K/W

Electrical Characteristics

$T_{\text{case}} = 25^{\circ}\text{C}$, unless otherwise specified

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Transistor							
Collector cut-off current	$V_{\text{CE}} = 600 \text{ V}$	TE13004D	I_{CES}			50	μA
	$V_{\text{CE}} = 700 \text{ V}$	TE13005D	I_{CES}			50	μA
	$V_{\text{CE}} = 600 \text{ V}; T_{\text{case}} = 150^{\circ}\text{C}$	TE13004D	I_{CES}			0.5	mA
	$V_{\text{CE}} = 700 \text{ V}; T_{\text{case}} = 150^{\circ}\text{C}$	TE13005D	I_{CES}			0.5	mA
Collector-emitter breakdown voltage (figure 1)	$I_{\text{C}} = 100 \text{ mA}; L = 125 \text{ mH}; I_{\text{measure}} = 100 \text{ mA}$	TE13004D	$V_{(\text{BR})\text{CEO}}$	300			V
		TE13005D	$V_{(\text{BR})\text{CEO}}$	400			V
Emitter-base breakdown voltage	$I_{\text{E}} = 1 \text{ mA}$		$V_{(\text{BR})\text{EBO}}$	9			V
Collector-emitter saturation voltage	$I_{\text{C}} = 2 \text{ A}; I_{\text{B}} = 0.4 \text{ A}$		V_{CEsat}			0.5	V
Base-emitter saturation voltage	$I_{\text{C}} = 2 \text{ A}; I_{\text{B}} = 0.4 \text{ A}$		V_{BEsat}			1.6	V
DC forward current transfer ratio	$V_{\text{CE}} = 2 \text{ V}; I_{\text{C}} = 10 \text{ mA}$		h_{FE}	10			
	$V_{\text{CE}} = 2 \text{ V}; I_{\text{C}} = 1 \text{ A}$		h_{FE}	10			
	$V_{\text{CE}} = 2 \text{ V}; I_{\text{C}} = 4 \text{ A}$		h_{FE}	4			
Dynamic saturation voltage	$I_{\text{C}} = 2 \text{ A}; I_{\text{B}} = 0.2 \text{ A}; t = 1 \mu\text{s}$		V_{CEsatdyn}		2.5		V
	$I_{\text{C}} = 2 \text{ A}; I_{\text{B}} = 0.2 \text{ A}; t = 3 \mu\text{s}$		V_{CEsatdyn}		0.6		V
Gain bandwidth product	$V_{\text{CE}} = 10 \text{ V}; I_{\text{C}} = 500 \text{ mA}; f = 1 \text{ MHz}$		f_{T}	4			MHz
Free-wheel diode							
Forward voltage	$I_{\text{F}} = 2 \text{ A}$		V_{F}		1.2	1.5	V
Turn-on transient peak voltage	$I_{\text{F}} = 2 \text{ A}; di_{\text{F}}/dt = 10 \text{ A}/\mu\text{s}$		V_{FP}		4	5	V
Reverse recovery current	$I_{\text{F}} = 2 \text{ A}; di_{\text{F}}/dt = 5 \text{ A}/\mu\text{s}; V_{\text{S}} = 200 \text{ V}$		I_{RM}		4		A

Switching Characteristics

$T_{\text{case}} = 25^{\circ}\text{C}$, unless otherwise specified

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Resistive load (figure 3)							
Turn on time	$I_C = 2\text{ A}$; $I_{B1} = -I_{B2} = 0.4\text{ A}$; $V_S = 125\text{ V}$		t_{on}		0.25	0.4	μs
Storage time			t_s		1.5	2.5	μs
Fall time			t_f		0.15	0.3	μs
Inductive load (figure 4)							
Storage time	$I_C = 2\text{ A}$; $I_{B1} = 0.4\text{ A}$; $L = 200\text{ }\mu\text{H}$; $V_{clamp} = 300\text{ V}$; $-V_{BE} = 5\text{ V}$; $T_{case} = 100^{\circ}\text{C}$		t_s		1.2	2	μs
Cross over time			t_c		0.4	0.7	μs
Free-wheel diode							
Reverse recovery time	$I_F = 0.5\text{ A}$; $I_R = 1\text{ A}$; $i_R = 0.25\text{ A}$		t_{rr}		0.7	1	μs
Forward recovery time	$I_F = 2\text{ A}$; $di_F/dt = 10\text{ A}/\mu\text{s}$		t_{fr}		0.4		μs
Reverse recovery time	$I_F = 2\text{ A}$; $-di_F/dt = 5\text{ A}/\mu\text{s}$		t_{rr}		1.1		μs
			t_{IRM}		0.9		μs

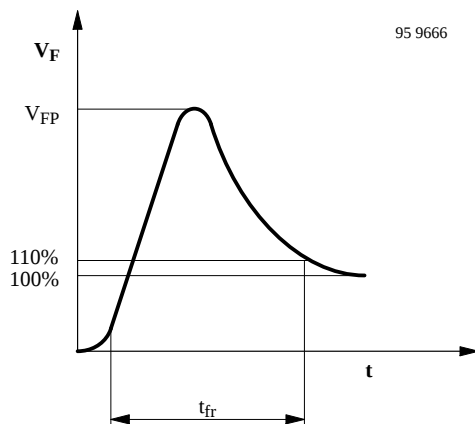


Figure 1. Turn on transient peak voltage

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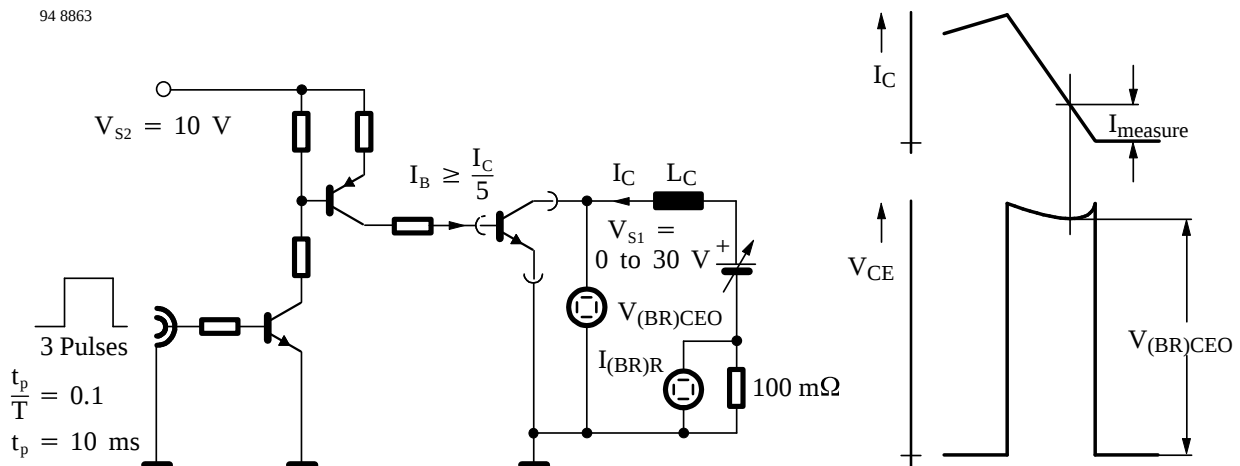


Figure 2. Test circuit for $V_{(BR)CEO}$

94 8852

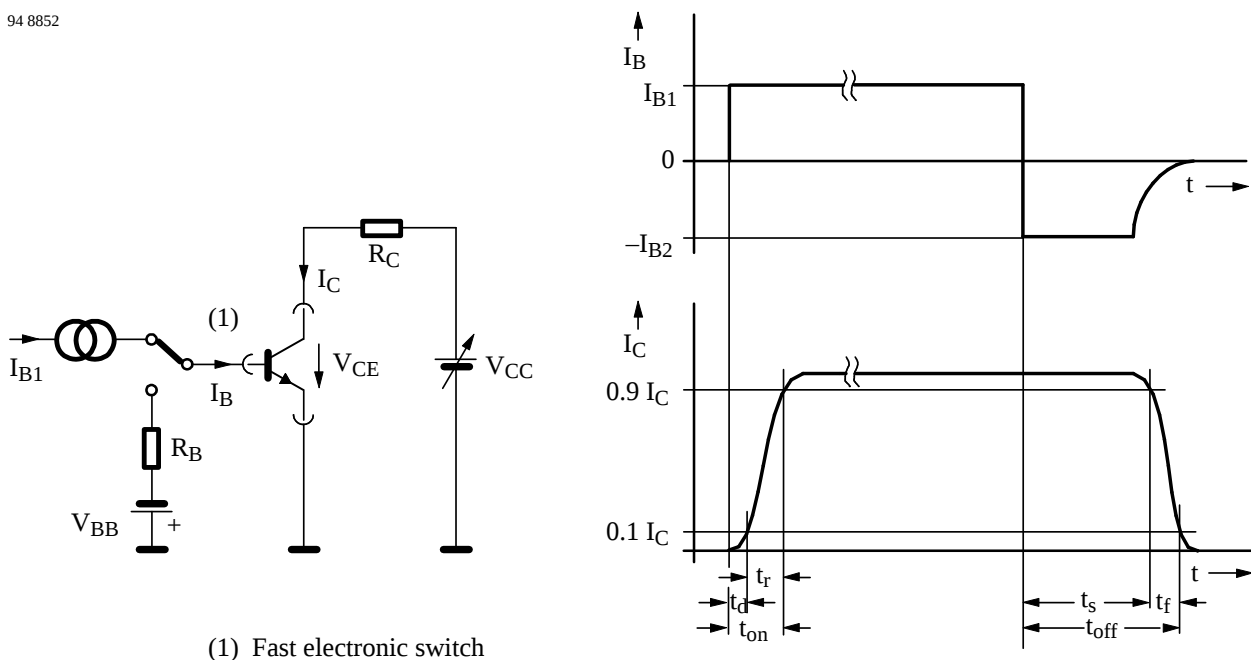


Figure 3. Test circuit for switching characteristics – resistive load

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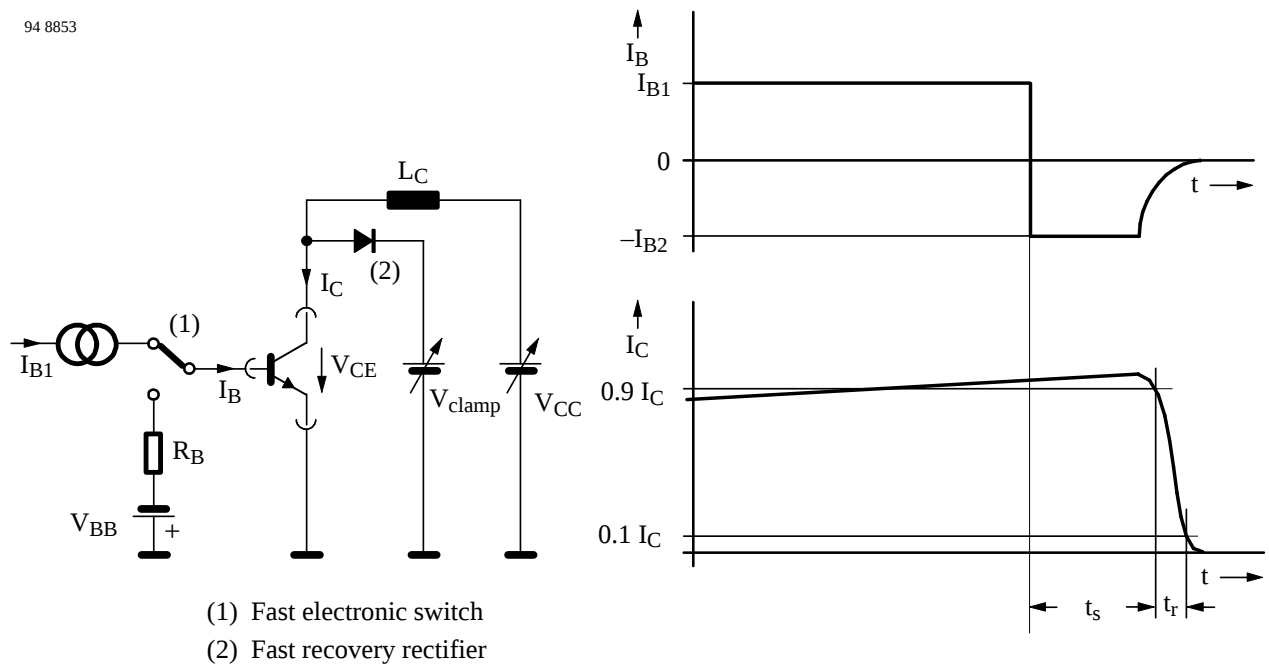


Figure 4. Test circuit for switching characteristics – inductive load

Typical Characteristics ($T_{\text{case}} = 25^{\circ}\text{C}$ unless otherwise specified)

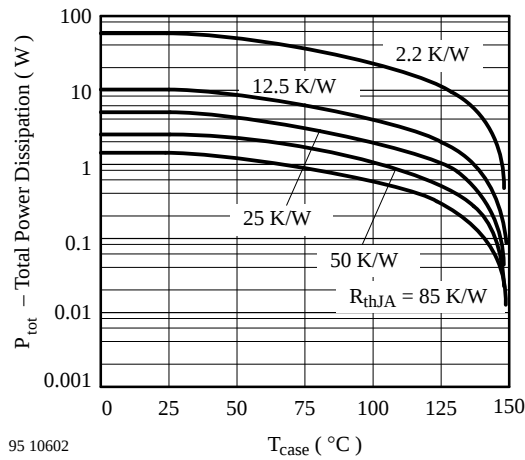


Figure 5. P_{tot} vs. T_{case}

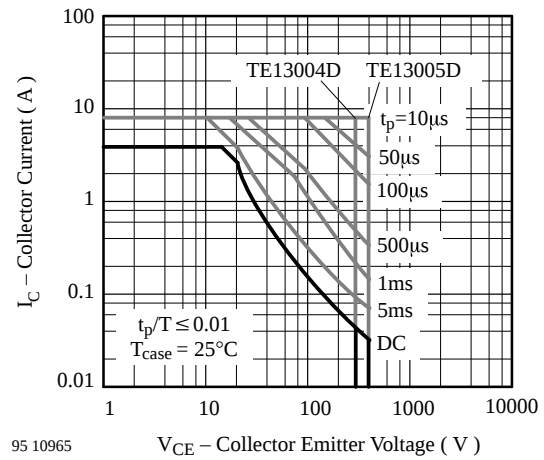


Figure 8. I_C vs. V_{CE}

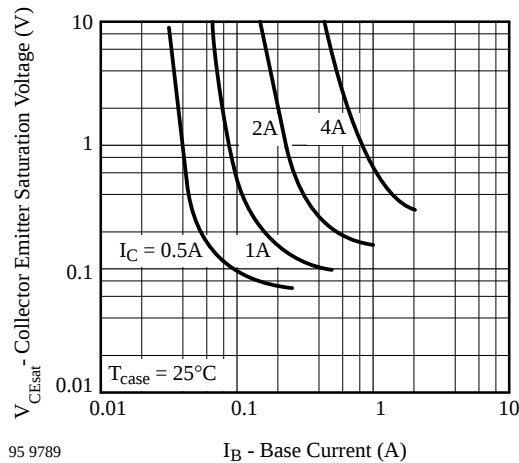


Figure 6. $V_{CE\text{sat}}$ vs. I_B

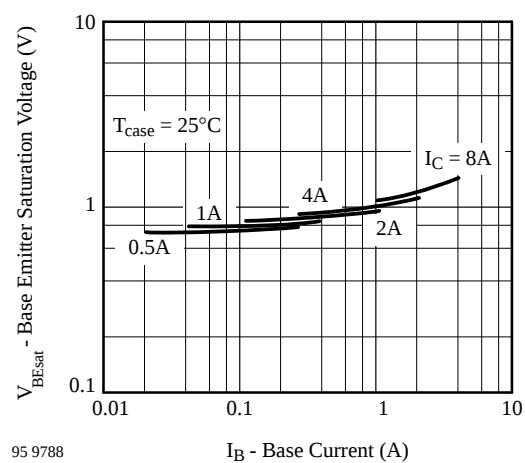


Figure 9. $V_{BE\text{sat}}$ vs. I_B

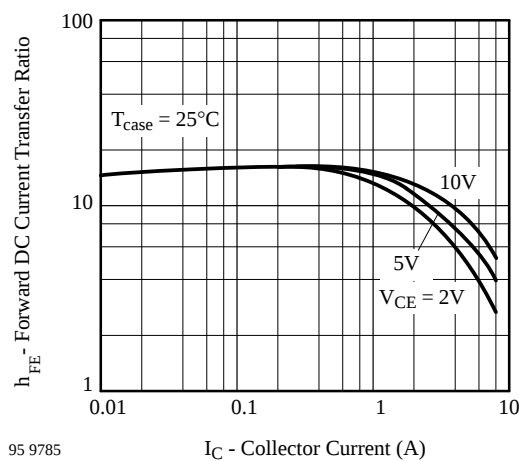


Figure 7. h_{FE} vs. I_C

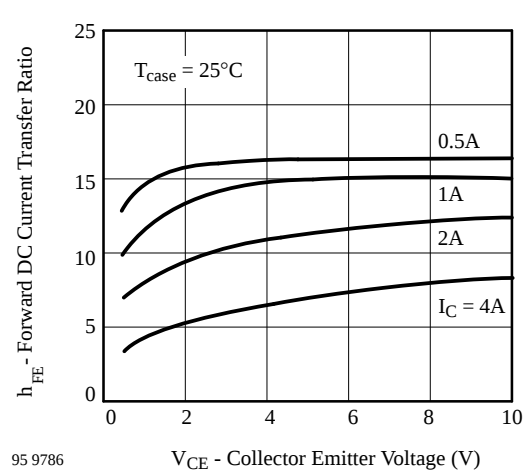


Figure 10. h_{FE} vs. V_{CE}

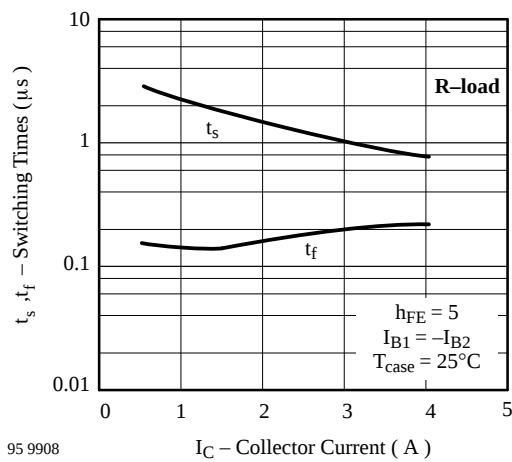


Figure 11. t_s, t_f vs. I_C

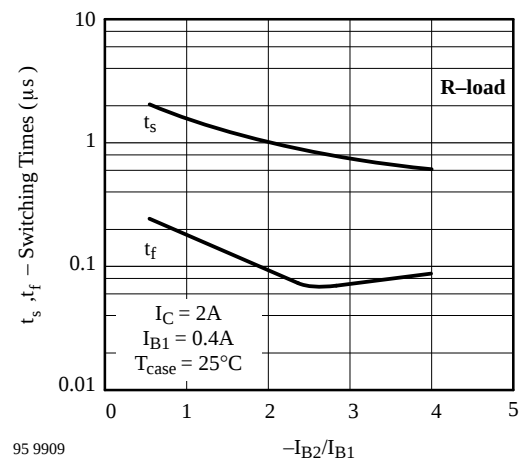


Figure 14. t_s, t_f vs. $-I_{B2}/I_{B1}$

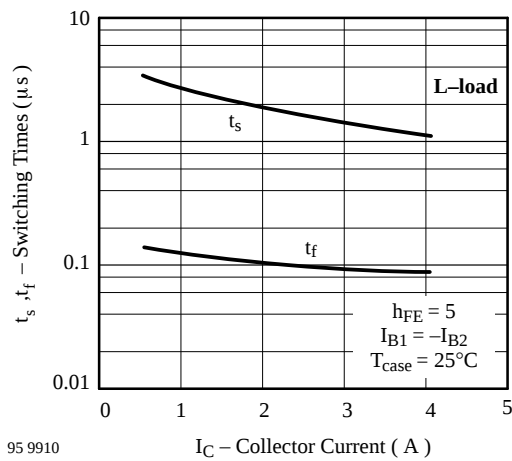


Figure 12. t_s, t_f vs. I_C

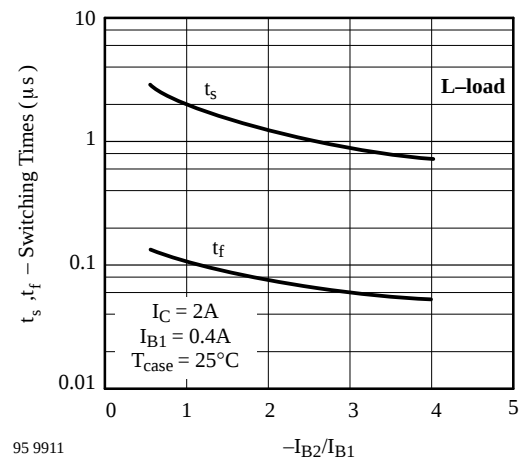


Figure 15. Error during Connect – 6107

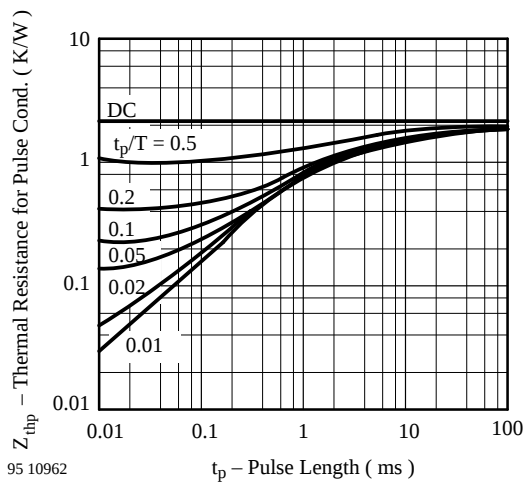
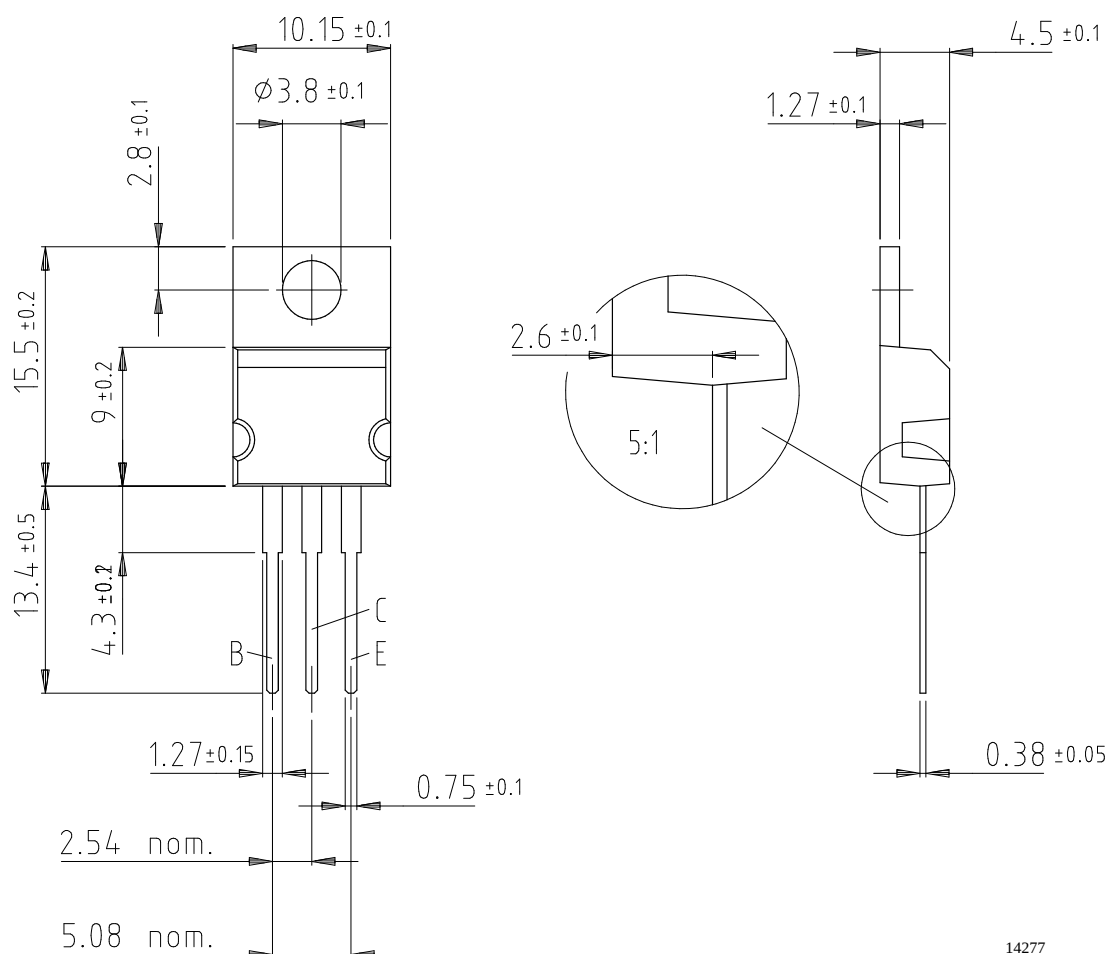
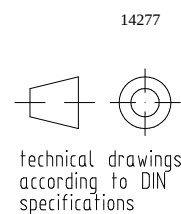


Figure 13.

Dimensions in mm



Plastic case JEDEC TO 220
Collector connected with metallic surface



Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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